

Data Sheet April 1995 File Number 3919.1

50A, 400V - 600V Hyperfast Diodes

RHRU5040, RHRU5050 and RHRU5060 (TA49065) are hyperfast diodes with soft recovery characteristics ($t_{RR} < 45$ ns). They have half the recovery time of ultrafast diodes and are silicon nitride passivated ion-implanted epitaxial planar construction.

These devices are intended for use as freewheeling/clamping diodes and rectifiers in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Ordering Information

PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND				
RHRU5040	TO-218	RHRU5040				
RHRU5050	TO-218	RHRU5050				
RHRU5060	TO-218	RHRU5060				

NOTE: When ordering, use the entire part number.

Features

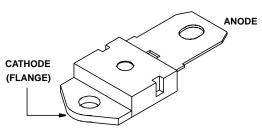
- · Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Package

JEDEC STYLE TO-218



Symbol



Absolute Maximum Ratings T_C = +25°C, Unless Otherwise Specified

	RHRU5040	RHRU5050	RHRU5060	UNITS
Peak Repetitive Reverse Voltage V _{RRM}	400	500	600	V
Working Peak Reverse Voltage V _{RWM}	400	500	600	V
DC Blocking VoltageV _R	400	500	600	V
Average Rectified Forward Current $I_{F(AV)}$ ($T_C = +93^{\circ}C$)	50	50	50	Α
Repetitive Peak Surge Current I _{FSM} (Square Wave, 20kHz)	100	100	100	Α
Nonrepetitive Peak Surge Current I _{FSM} (Halfwave, 1 Phase, 60Hz)	500	500	500	Α
Maximum Power Dissipation	150	150	150	W
Avalanche Energy (L = 40mH) E _{AVL}	40	40	40	mj
Operating and Storage Temperature T _{STG} , T _J	-65 to +175	-65 to +175	-65 to +175	°C

RHRU5040, RHRU5050, RHRU5060

Electrical Specifications $T_C = +25^{\circ}C$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	F	RHRU5040		RHRU5050		RHRU5060				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
V _F	$I_F = 50A, T_C = +25^{\circ}C$	-	-	2.1	-	-	2.1	-	-	2.1	V
	I _F = 50A, T _C = +150 ^o C	-	-	1.7	-	-	1.7	-	-	1.7	V
I _R	$V_R = 400V, T_C = +25^{\circ}C$	-	-	500	-	-	-	-	-	-	μΑ
	$V_R = 500V, T_C = +25^{\circ}C$	-	-	-	-	-	500	-	-	-	μΑ
	$V_R = 600V, T_C = +25^{\circ}C$	-	-	-	-	-	-	-	-	500	μΑ
I _R	$V_R = 400V, T_C = +150^{\circ}C$	-	-	1.5	-	-	-	-	-	-	mA
	$V_R = 500V, T_C = +150^{\circ}C$	-	-	-	-	-	1.5	-	-	-	mA
	$V_R = 600V, T_C = +150^{\circ}C$	-	-	-	-	-	-	-	-	1.5	mA
t _{RR}	I _F = 1A, dI _F /dt = 100A/μs	-	-	45	-	-	45	-	-	45	ns
	I _F = 50A, dI _F /dt = 100A/μs	-	-	50	-	-	50	-	-	50	ns
t _A	$I_F = 50A$, $dI_F/dt = 100A/\mu s$	-	25	-	-	25	-	-	25	-	ns
t _B	$I_F = 50A$, $dI_F/dt = 100A/\mu s$	-	20	-	-	20	-	-	20	-	ns
Q _{RR}	I _F = 50A, dI _F /dt = 100A/μs	-	65	-	-	65	-	-	65	-	nC
СЈ	$V_R = 10V, I_F = 0A$	-	140	-	-	140	-	-	140	-	pF
$R_{\theta JC}$		-	-	1.0	-	-	1.0	-	-	1.0	oC/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

 I_R = Instantaneous reverse current.

 t_{RR} = Reverse recovery time (See Figure 2), summation of t_{A} + t_{B} .

 $t_{\mbox{\scriptsize A}}$ = Time to reach peak reverse current (See Figure 2).

t_B = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 2).

 $R_{\theta JC}$ = Thermal resistance junction to case.

 E_{AVL} = Controlled avalanche energy (See Figures 10 and 11).

pw = pulse width.

D = duty cycle.

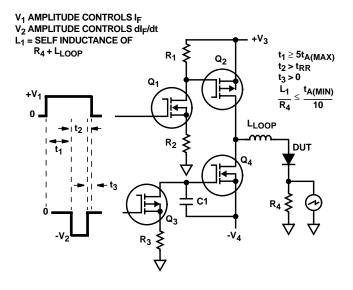


FIGURE 1. t_{RR} TEST CIRCUIT

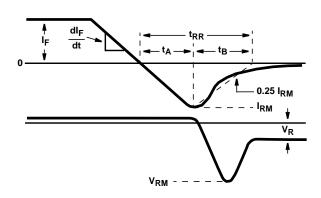


FIGURE 2. $t_{\mbox{\scriptsize RR}}$ WAVEFORMS AND DEFINITIONS

Typical Performance Curves

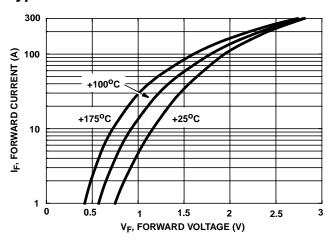


FIGURE 3. TYPICAL FORWARD CURRENT vs FORWARD VOLTAGE DROP

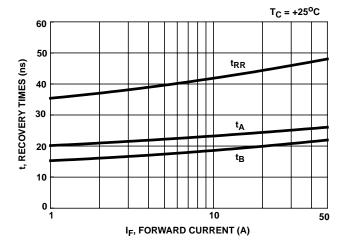


FIGURE 5. TYPICAL t_{RR} , t_A AND t_B CURVES vs FORWARD CURRENT AT +25°C

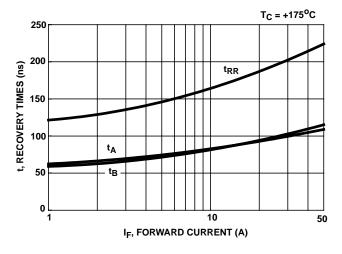


FIGURE 7. TYPICAL t_{RR} , t_{A} AND t_{B} CURVES vs FORWARD CURRENT AT +175°C

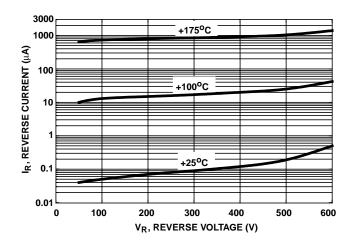


FIGURE 4. TYPICAL REVERSE CURRENT vs REVERSE VOLTAGE

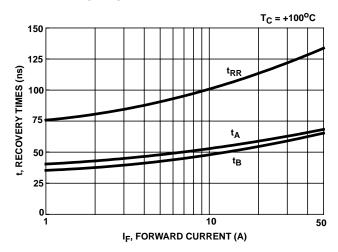


FIGURE 6. TYPICAL t_{RR} , t_A AND t_B CURVES vs FORWARD CURRENT AT +100 $^{\circ}$ C

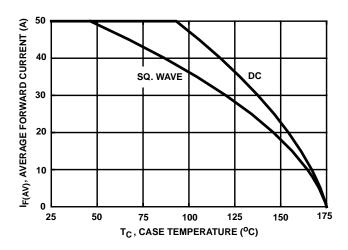


FIGURE 8. CURRENT DERATING CURVE FOR ALL TYPES

Typical Performance Curves (Continued)

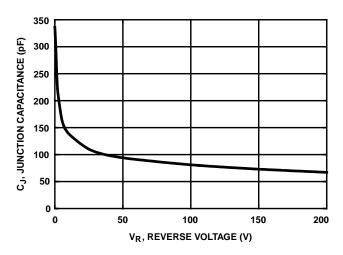
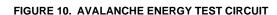


FIGURE 9. TYPICAL JUNCTION CAPACITANCE vs REVERSE VOLTAGE

Test Circuit and Waveforms

 $\begin{array}{c} \text{IMAX} = 1\text{A} \\ \text{L} = 40\text{mH} \\ \text{R} < 0.1\Omega \\ \text{EAVL} = 1/2\text{LI}^2 \left[\text{VAVL}/(\text{VAVL} - \text{VDD}) \right] \\ \text{Q}_1 \text{ AND } \text{Q}_2 \text{ ARE 1000V MOSFETs} \\ \text{Q}_1 \\ \text{V}_{DD} \\ \text{V}_{DD} \\ \text{V}_{DD} \\ \text{SENSE} \\ \text{V}_{DD} \\ \text{O}_{D} \\ \text{V}_{DD} \\ \text{V}_{DD$



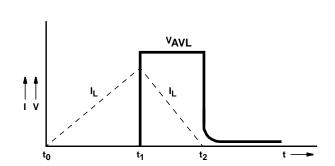


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

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